

Corrigendum

Date: Dec 29, 2014

This is with reference to NPCI's RFQ: 2014-15/0023 Dated 12.12.2014 for Empanelment of Vendor for Manufacturing RuPay Holograms. The prospective proposers may please note that in the aforesaid RFQ, the following clauses are amended.

Amendment is as under:

Description	Wording from existing RFQ	Amendment vide this letter
3.1 – (IV) – Scope of Work	The diagrammatic representation of RuPay hologram for dimensions post hot stamping and post hot stamping are as under.	The diagrammatic representation of RuPay hologram for dimensions pre hot stamping and post hot stamping are as under.
3.1 - II(IV) - Scope of Work	Vacuum metallized 19 to 23 Micron Polyester film of Silver and Gold shade to be used.	Vacuum metallized 19 to 23 Micron hot stamping hologram foil based on a polyester carrier of Silver and Gold shade to be used.
6.2(IV) Opening of Envelope B - Technical Bid	The bidder needs to produce THHMS* certificate.	The bidder needs to produce TUV:HOMAI HSSMS certificate

* For each instance THHMS / HSSMS is replaced by TUV: HOMAI HSSMS in the RFQ 2014-15/0023 Dated 12.12.2014 for Empanelment of Vendor for Manufacturing RuPay Hologram.



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All other terms and conditions of aforesaid RFQ remain unchanged.

MD & CHIEF EXECUTIVE OFFICER

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